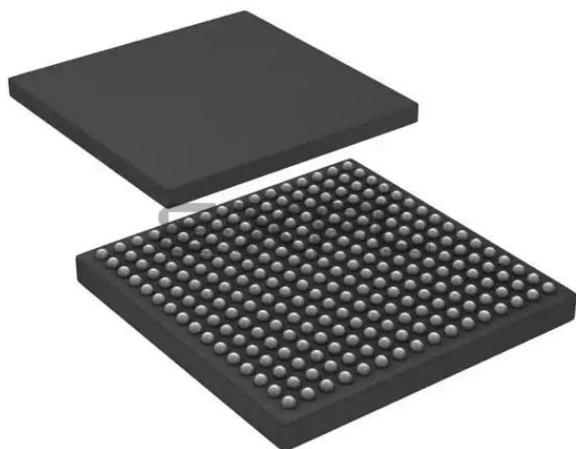




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Details

Product Status	Active
Core Processor	ARM® Cortex® -M4/M0
Core Size	32-Bit Dual-Core
Speed	204MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I ² C, IrDA, Microwire, QEI, SD, SPI, SSI, SSP, UART/USART, USB, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, I ² S, Motor Control PWM, POR, PWM, WDT
Number of I/O	164
Program Memory Size	1MB (1M x 8)
Program Memory Type	FLASH
EEPROM Size	16K x 8
RAM Size	136K x 8
Voltage - Supply (Vcc/Vdd)	2.2V ~ 3.6V
Data Converters	A/D 8x10b; D/A 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	256-LBGA
Supplier Device Package	256-LBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/lpc4337jet256-551

6. Pinning information

6.1 Pinning

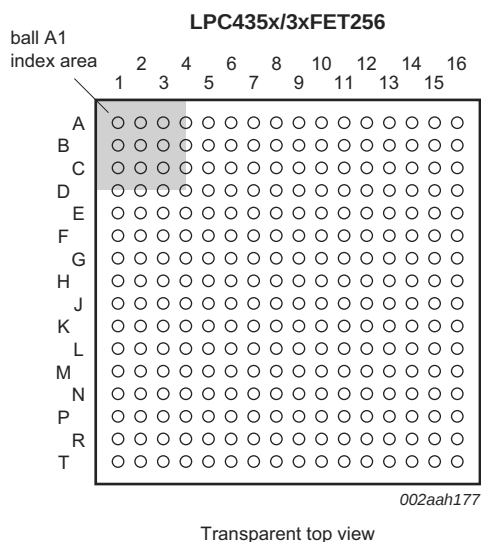


Fig 2. Pin configuration LBGA256 package

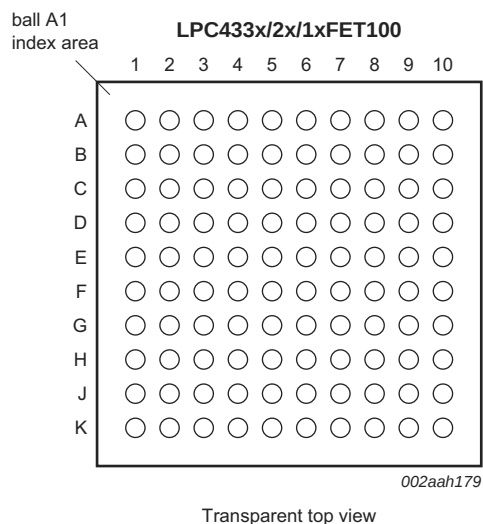


Fig 3. Pin configuration TFBGA100 package

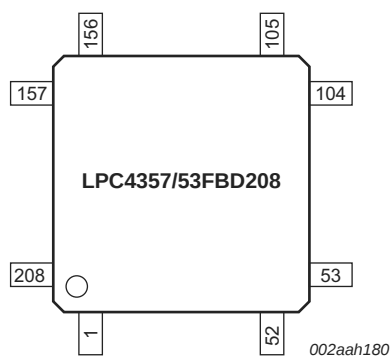


Fig 4. Pin configuration LQFP208 package

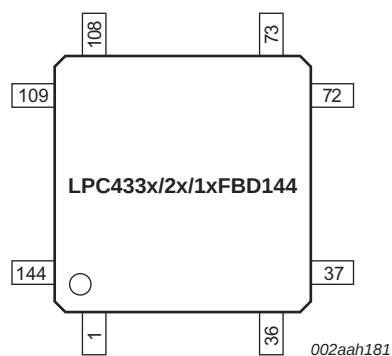


Fig 5. Pin configuration LQFP144 package

Table 3. Pin description ...continued

Pin name	LBGA256	TFBGA100	LQFP208	LQFP144		Reset state [1]	Type	Description
P1_20	M10	K10	100	70	[2]	N; PU	I/O	GPIO0[15] — General purpose digital input/output pin.
							I/O	SSP1_SSEL — Slave Select for SSP1.
							-	R — Function reserved.
							O	ENET_TXD1 — Ethernet transmit data 1 (RMII/MII interface).
							I	T0_CAP2 — Capture input 2 of timer 0.
							-	R — Function reserved.
							I/O	SGPIO13 — General purpose digital input/output pin.
							I/O	EMC_D11 — External memory data line 11.
P2_0	T16	G10	108	75	[2]	N; PU	I/O	SGPIO4 — General purpose digital input/output pin.
							O	U0_TXD — Transmitter output for USART0. See Table 4 for ISP mode.
							I/O	EMC_A13 — External memory address line 13.
							O	USB_PPWR — VBUS drive signal (towards external charge pump or power management unit); indicates that VBUS must be driven (active HIGH). Add a pull-down resistor to disable the power switch at reset. This signal has opposite polarity compared to the USB_PPWR used on other NXP LPC parts.
							I/O	GPIO5[0] — General purpose digital input/output pin.
							-	R — Function reserved.
							I	T3_CAP0 — Capture input 0 of timer 3.
							O	ENET_MDC — Ethernet MIIM clock.
P2_1	N15	G7	116	81	[2]	N; PU	I/O	SGPIO5 — General purpose digital input/output pin.
							I	U0_RXD — Receiver input for USART0. See Table 4 for ISP mode.
							I/O	EMC_A12 — External memory address line 12.
							I	USB_PWR_FAULT — Port power fault signal indicating overcurrent condition; this signal monitors over-current on the USB bus (external circuitry required to detect over-current condition).
							I/O	GPIO5[1] — General purpose digital input/output pin.
							-	R — Function reserved.
							I	T3_CAP1 — Capture input 1 of timer 3.
							-	R — Function reserved.

Table 3. Pin description ...continued

Pin name	LBGA256	TFBGA100	LQFP208	LQFP144		Reset state [1]	Type	Description
P2_2	M15	F5	121	84	[2]	N; PU	I/O	SGPIO6 — General purpose digital input/output pin.
							I/O	U0_UCLK — Serial clock input/output for USART0 in synchronous mode.
							I/O	EMC_A11 — External memory address line 11.
							O	USB0_IND1 — USB0 port indicator LED control output 1.
							I/O	GPIO5[2] — General purpose digital input/output pin.
							I	CTIN_6 — SCT input 6. Capture input 1 of timer 3.
							I	T3_CAP2 — Capture input 2 of timer 3.
							O	EMC_CS1 — LOW active Chip Select 1 signal.
P2_3	J12	D8	127	87	[3]	N; PU	I/O	SGPIO12 — General purpose digital input/output pin.
							I/O	I2C1_SDA — I ² C1 data input/output (this pin does not use a specialized I2C pad).
							O	U3_TXD — Transmitter output for USART3. See Table 4 for ISP mode.
							I	CTIN_1 — SCT input 1. Capture input 1 of timer 0. Capture input 1 of timer 2.
							I/O	GPIO5[3] — General purpose digital input/output pin.
							-	R — Function reserved.
							O	T3_MAT0 — Match output 0 of timer 3.
							O	USB0_PPWR — VBUS drive signal (towards external charge pump or power management unit); indicates that VBUS must be driven (active HIGH). Add a pull-down resistor to disable the power switch at reset. This signal has opposite polarity compared to the USB_PPWR used on other NXP LPC parts.
P2_4	K11	D9	128	88	[3]	N; PU	I/O	SGPIO13 — General purpose digital input/output pin.
							I/O	I2C1_SCL — I ² C1 clock input/output (this pin does not use a specialized I2C pad).
							I	U3_RXD — Receiver input for USART3. See Table 4 for ISP mode.
							I	CTIN_0 — SCT input 0. Capture input 0 of timer 0, 1, 2, 3.
							I/O	GPIO5[4] — General purpose digital input/output pin.
							-	R — Function reserved.
							O	T3_MAT1 — Match output 1 of timer 3.
							I	USB0_PWR_FAULT — Port power fault signal indicating overcurrent condition; this signal monitors over-current on the USB bus (external circuitry required to detect over-current condition).

Table 3. Pin description ...continued

Pin name	LBGA256	TFBGA100	LQFP208	LQFP144		Reset state [1]	Type	Description
P3_5	C12	B7	173	121	[2]	N; PU	I/O	GPIO1[15] — General purpose digital input/output pin.
							-	R — Function reserved.
							-	R — Function reserved.
							I/O	SPIFI_SIO2 — I/O lane 2 for SPIFI.
							I	U1_RXD — Receiver input for UART 1.
							I/O	I2S0_TX_SDA — I2S transmit data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the <i>I²S-bus specification</i> .
							I/O	I2S1_RX_WS — Receive Word Select. It is driven by the master and received by the slave. Corresponds to the signal WS in the <i>I²S-bus specification</i> .
							O	LCD_VD12 — LCD data.
P3_6	B13	C7	174	122	[2]	N; PU	I/O	GPIO0[6] — General purpose digital input/output pin.
							I/O	SPI_MISO — Master In Slave Out for SPI.
							I/O	SSP0_SSEL — Slave Select for SSP0.
							I/O	SPIFI_MISO — Input 1 in SPIFI quad mode; SPIFI output IO1.
							-	R — Function reserved.
							I/O	SSP0_MISO — Master In Slave Out for SSP0.
							-	R — Function reserved.
P3_7	C11	D7	176	123	[2]	N; PU	-	R — Function reserved.
							I/O	SPI_MOSI — Master Out Slave In for SPI.
							I/O	SSP0_MISO — Master In Slave Out for SSP0.
							I/O	SPIFI_MOSI — Input IO in SPIFI quad mode; SPIFI output IO0.
							I/O	GPIO5[10] — General purpose digital input/output pin.
							I/O	SSP0_MOSI — Master Out Slave in for SSP0.
							-	R — Function reserved.
P3_8	C10	E7	179	124	[2]	N; PU	-	R — Function reserved.
							I	SPI_SSEL — Slave Select for SPI. Note that this pin in an input pin only. The SPI in master mode cannot drive the CS input on the slave. Any GPIO pin can be used for SPI chip select in master mode.
							I/O	SSP0_MOSI — Master Out Slave in for SSP0.
							I/O	SPIFI_CS — SPIFI serial flash chip select.
							I/O	GPIO5[11] — General purpose digital input/output pin.
							I/O	SSP0_SSEL — Slave Select for SSP0.
							-	R — Function reserved.
P3_8	C10	E7	179	124	[2]	N; PU	-	R — Function reserved.
							-	R — Function reserved.

Table 3. Pin description ...continued

Pin name	LPGA256	TFBGA100	LQFP208	LQFP144		Reset state [1]	Type	Description
P5_4	P9	-	80	57	[2]	N; PU	I/O	GPIO2[13] — General purpose digital input/output pin.
							O	MCOB0 — Motor control PWM channel 0, output B.
							I/O	EMC_D8 — External memory data line 8.
							-	R — Function reserved.
							I	U1_CTS — Clear to Send input for UART 1.
							O	T1_MAT0 — Match output 0 of timer 1.
							-	R — Function reserved.
							-	R — Function reserved.
P5_5	P10	-	81	58	[2]	N; PU	I/O	GPIO2[14] — General purpose digital input/output pin.
							O	MCOA1 — Motor control PWM channel 1, output A.
							I/O	EMC_D9 — External memory data line 9.
							-	R — Function reserved.
							I	U1_DCD — Data Carrier Detect input for UART 1.
							O	T1_MAT1 — Match output 1 of timer 1.
							-	R — Function reserved.
							-	R — Function reserved.
P5_6	T13	-	89	63	[2]	N; PU	I/O	GPIO2[15] — General purpose digital input/output pin.
							O	MCOB1 — Motor control PWM channel 1, output B.
							I/O	EMC_D10 — External memory data line 10.
							-	R — Function reserved.
							O	U1_TXD — Transmitter output for UART 1.
							O	T1_MAT2 — Match output 2 of timer 1.
							-	R — Function reserved.
							-	R — Function reserved.
P5_7	R12	-	91	65	[2]	N; PU	I/O	GPIO2[7] — General purpose digital input/output pin.
							O	MCOA2 — Motor control PWM channel 2, output A.
							I/O	EMC_D11 — External memory data line 11.
							-	R — Function reserved.
							I	U1_RXD — Receiver input for UART 1.
							O	T1_MAT3 — Match output 3 of timer 1.
							-	R — Function reserved.
							-	R — Function reserved.

Table 3. Pin description ...continued

Pin name	LPGA256	TFBGA100	LQFP208	LQFP144		Reset state [1]	Type	Description
P6_3	P15	-	113	79	[2]	N; PU	I/O	GPIO3[2] — General purpose digital input/output pin.
							O	USB0_PPWR — VBUS drive signal (towards external charge pump or power management unit); indicates that the VBUS signal must be driven (active HIGH). Add a pull-down resistor to disable the power switch at reset. This signal has opposite polarity compared to the USB_PPWR used on other NXP LPC parts.
							I/O	SGPIO4 — General purpose digital input/output pin.
							O	EMC_CS1 — LOW active Chip Select 1 signal.
							-	R — Function reserved.
							I	T2_CAP2 — Capture input 2 of timer 2.
							-	R — Function reserved.
							-	R — Function reserved.
P6_4	R16	F6	114	80	[2]	N; PU	I/O	GPIO3[3] — General purpose digital input/output pin.
							I	CTIN_6 — SCT input 6. Capture input 1 of timer 3.
							O	U0_TXD — Transmitter output for USART0.
							O	EMC_CAS — LOW active SDRAM Column Address Strobe.
							-	R — Function reserved.
							-	R — Function reserved.
							-	R — Function reserved.
							-	R — Function reserved.
P6_5	P16	F9	117	82	[2]	N; PU	I/O	GPIO3[4] — General purpose digital input/output pin.
							O	CTOUT_6 — SCT output 6. Match output 2 of timer 1.
							I	U0_RXD — Receiver input for USART0.
							O	EMC_RAS — LOW active SDRAM Row Address Strobe.
							-	R — Function reserved.
							-	R — Function reserved.
							-	R — Function reserved.
							-	R — Function reserved.
P6_6	L14	-	119	83	[2]	N; PU	I/O	GPIO0[5] — General purpose digital input/output pin.
							O	EMC_BLS1 — LOW active Byte Lane select signal 1.
							I/O	SGPIO5 — General purpose digital input/output pin.
							I	USB0_PWR_FAULT — Port power fault signal indicating overcurrent condition; this signal monitors over-current on the USB bus (external circuitry required to detect over-current condition).
							-	R — Function reserved.
							I	T2_CAP3 — Capture input 3 of timer 2.
							-	R — Function reserved.
							-	R — Function reserved.

Table 3. Pin description ...continued

Pin name	LBGA256	TFBGA100	LQFP208	LQFP144		Reset state [1]	Type	Description
P6_7	J13	-	123	85	[2]	N; PU	-	R — Function reserved.
							I/O	EMC_A15 — External memory address line 15.
							I/O	SGPIO6 — General purpose digital input/output pin.
							O	USB0_IND1 — USB0 port indicator LED control output 1.
							I/O	GPIO5[15] — General purpose digital input/output pin.
							O	T2_MAT0 — Match output 0 of timer 2.
							-	R — Function reserved.
							-	R — Function reserved.
P6_8	H13	-	125	86	[2]	N; PU	-	R — Function reserved.
							I/O	EMC_A14 — External memory address line 14.
							I/O	SGPIO7 — General purpose digital input/output pin.
							O	USB0_IND0 — USB0 port indicator LED control output 0.
							I/O	GPIO5[16] — General purpose digital input/output pin.
							O	T2_MAT1 — Match output 1 of timer 2.
							-	R — Function reserved.
							-	R — Function reserved.
P6_9	J15	F8	139	97	[2]	N; PU	I/O	GPIO3[5] — General purpose digital input/output pin.
							-	R — Function reserved.
							-	R — Function reserved.
							O	EMC_DYCS0 — SDRAM chip select 0.
							-	R — Function reserved.
							O	T2_MAT2 — Match output 2 of timer 2.
							-	R — Function reserved.
							-	R — Function reserved.
P6_10	H15	-	142	100	[2]	N; PU	I/O	GPIO3[6] — General purpose digital input/output pin.
							O	MCABORT — Motor control PWM, LOW-active fast abort.
							-	R — Function reserved.
							O	EMC_DQMOUT1 — Data mask 1 used with SDRAM and static devices.
							-	R — Function reserved.
							-	R — Function reserved.
							-	R — Function reserved.
							-	R — Function reserved.

Table 3. Pin description ...continued

Pin name	LPGA256	TFBGA100	LQFP208	LQFP144		Reset state [1]	Type	Description
PD_11	N9	-	88	-	[2]	N; PU	-	R — Function reserved.
							-	R — Function reserved.
							O	EMC_CS3 — LOW active Chip Select 3 signal.
							-	R — Function reserved.
							I/O	GPIO6[25] — General purpose digital input/output pin.
							I/O	USB1_ULPI_D0 — ULPI link bidirectional data line 0.
							O	CTOUT_14 — SCT output 14. Match output 2 of timer 3.
							-	R — Function reserved.
PD_12	N11	-	94	-	[2]	N; PU	-	R — Function reserved.
							-	R — Function reserved.
							O	EMC_CS2 — LOW active Chip Select 2 signal.
							-	R — Function reserved.
							I/O	GPIO6[26] — General purpose digital input/output pin.
							-	R — Function reserved.
							O	CTOUT_10 — SCT output 10. Match output 3 of timer 3.
PD_13	T14	-	97	-	[2]	N; PU	-	R — Function reserved.
							I	CTIN_0 — SCT input 0. Capture input 0 of timer 0, 1, 2, 3.
							O	EMC_BLS2 — LOW active Byte Lane select signal 2.
							-	R — Function reserved.
							I/O	GPIO6[27] — General purpose digital input/output pin.
							-	R — Function reserved.
							O	CTOUT_13 — SCT output 13. Match output 3 of timer 3.
PD_14	R13	-	99	-	[2]	N; PU	-	R — Function reserved.
							-	R — Function reserved.
							O	EMC_DYCS2 — SDRAM chip select 2.
							-	R — Function reserved.
							I/O	GPIO6[28] — General purpose digital input/output pin.
							-	R — Function reserved.
							O	CTOUT_11 — SCT output 11. Match output 3 of timer 2.
PD_14	R13	-	99	-	[2]	N; PU	-	R — Function reserved.

Table 3. Pin description ...continued

Pin name	LBGA256	TFBGA100	LQFP208	LQFP144		Reset state [1]	Type	Description
PF_9	D6	-	203	-	[5]	N; PU	-	R — Function reserved.
							I/O	U0_DIR — RS-485/EIA-485 output enable/direction control for USART0.
							O	CTOUT_1 — SCT output 1. Match output 3 of timer 3.
							-	R — Function reserved.
							I/O	GPIO7[23] — General purpose digital input/output pin.
							-	R — Function reserved.
							I/O	SGPIO3 — General purpose digital input/output pin.
							-	R — Function reserved.
PF_10	A3	-	205	-	[5]	N; PU	AI	ADC1_2 — ADC1 and ADC0, input channel 2. Configure the pin as GPIO input and use the ADC function select register in the SCU to select the ADC.
							-	R — Function reserved.
							O	U0_TXD — Transmitter output for USART0.
							-	R — Function reserved.
							-	R — Function reserved.
							I/O	GPIO7[24] — General purpose digital input/output pin.
							-	R — Function reserved.
							I	SD_WP — SD/MMC card write protect input.
PF_11	A2	-	207	-	[5]	N; PU	-	R — Function reserved.
							I	U0_RXD — Receiver input for USART0.
							-	R — Function reserved.
							-	R — Function reserved.
							I/O	GPIO7[25] — General purpose digital input/output pin.
							-	R — Function reserved.
							O	SD_VOLT2 — SD/MMC bus voltage select output 2.
							-	R — Function reserved.
							AI	ADC1_5 — ADC1 and ADC0, input channel 5. Configure the pin as GPIO input and use the ADC function select register in the SCU to select the ADC.
							-	R — Function reserved.

7.19.6.1 Features

- The I²S interfaces has separate input/output channels, each of which can operate in master or slave mode.
- Capable of handling 8-bit, 16-bit, and 32-bit word sizes.
- Mono and stereo audio data supported.
- The sampling frequency can range from 16 kHz to 192 kHz (16, 22.05, 32, 44.1, 48, 96, 192) kHz.
- Support for an audio master clock.
- Configurable word select period in master mode (separately for I²S-bus input and output).
- Two 8-word FIFO data buffers are provided, one for transmit and one for receive.
- Generates interrupt requests when buffer levels cross a programmable boundary.
- Two DMA requests controlled by programmable buffer levels. The DMA requests are connected to the GPDMA block.
- Controls include reset, stop and mute options separately for I²S-bus input and I²S-bus output.

7.19.7 C_CAN

Remark: The LPC435x/3x/2x/1x each contain two C_CAN controllers.

Controller Area Network (CAN) is the definition of a high performance communication protocol for serial data communication. The C_CAN controller is designed to provide a full implementation of the CAN protocol according to the CAN Specification Version 2.0B. The C_CAN controller allows to build powerful local networks with low-cost multiplex wiring by supporting distributed real-time control with a high level of reliability.

7.19.7.1 Features

- Conforms to protocol version 2.0 parts A and B.
- Supports bit rate of up to 1 Mbit/s.
- Supports 32 Message Objects.
- Each Message Object has its own identifier mask.
- Provides programmable FIFO mode (concatenation of Message Objects).
- Provides maskable interrupts.
- Supports Disabled Automatic Retransmission (DAR) mode for time-triggered CAN applications.
- Provides programmable loop-back mode for self-test operation.

7.20 Counter/timers and motor control

7.20.1 General purpose 32-bit timers/external event counters

Remark: The LPC435x/3x/2x/1x include four 32-bit timer/counters.

The timer/counter is designed to count cycles of the system derived clock or an externally-supplied clock. It can optionally generate interrupts, generate timed DMA requests, or perform other actions at specified timer values, based on four match registers. Each timer/counter also includes two capture inputs to trap the timer value when an input signal transitions, optionally generating an interrupt.

7.20.1.1 Features

- A 32-bit timer/counter with a programmable 32-bit prescaler.
- Counter or timer operation.
- Two 32-bit capture channels per timer, that can take a snapshot of the timer value when an input signal transitions. A capture event can also generate an interrupt.
- Four 32-bit match registers that allow:
 - Continuous operation with optional interrupt generation on match.
 - Stop timer on match with optional interrupt generation.
 - Reset timer on match with optional interrupt generation.
- Up to four external outputs corresponding to match registers, with the following capabilities:
 - Set LOW on match.
 - Set HIGH on match.
 - Toggle on match.
 - Do nothing on match.
- Up to two match registers can be used to generate timed DMA requests.

7.20.2 Motor control PWM

The motor control PWM is a specialized PWM supporting 3-phase motors and other combinations. Feedback inputs are provided to automatically sense rotor position and use that information to ramp speed up or down. An abort input causes the PWM to release all motor drive outputs immediately. At the same time, the motor control PWM is highly configurable for other generalized timing, counting, capture, and compare applications.

7.20.3 Quadrature Encoder Interface (QEI)

A quadrature encoder, also known as a 2-channel incremental encoder, converts angular displacement into two pulse signals. By monitoring both the number of pulses and the relative phase of the two signals, the user code can track the position, direction of rotation, and velocity. In addition, a third channel, or index signal, can be used to reset the position counter. The quadrature encoder interface decodes the digital pulses from a quadrature encoder wheel to integrate position over time and determine direction of rotation. In addition, the QEI can capture the velocity of the encoder wheel.

7.20.3.1 Features

- Tracks encoder position.
- Increments/decrements depending on direction.
- Programmable for 2× or 4× position counting.
- Velocity capture using built-in timer.
- Velocity compare function with “less than” interrupt.

- Uses 32-bit registers for position and velocity.
- Three position compare registers with interrupts.
- Index counter for revolution counting.
- Index compare register with interrupts.
- Can combine index and position interrupts to produce an interrupt for whole and partial revolution displacement.
- Digital filter with programmable delays for encoder input signals.
- Can accept decoded signal inputs (clk and direction).

7.20.4 Repetitive Interrupt (RI) timer

The repetitive interrupt timer provides a free-running 32-bit counter which is compared to a selectable value, generating an interrupt when a match occurs. Any bits of the timer/compare function can be masked such that they do not contribute to the match detection. The repetitive interrupt timer can be used to create an interrupt that repeats at predetermined intervals.

7.20.4.1 Features

- 32-bit counter. Counter can be free-running or be reset by a generated interrupt.
- 32-bit compare value.
- 32-bit compare mask. An interrupt is generated when the counter value equals the compare value, after masking. This mechanism allows for combinations not possible with a simple compare.

7.20.5 Windowed WatchDog Timer (WWDT)

The purpose of the watchdog is to reset the controller if software fails to periodically service it within a programmable time window.

7.20.5.1 Features

- Internally resets chip if not periodically reloaded during the programmable time-out period.
- Optional windowed operation requires reload to occur between a minimum and maximum time period, both programmable.
- Optional warning interrupt can be generated at a programmable time prior to watchdog time-out.
- Enabled by software but requires a hardware reset or a watchdog reset/interrupt to be disabled.
- Incorrect feed sequence causes reset or interrupt if enabled.
- Flag to indicate watchdog reset.
- Programmable 24-bit timer with internal prescaler.
- Selectable time period from $(T_{cy(WDCLK)} \times 256 \times 4)$ to $(T_{cy(WDCLK)} \times 2^{24} \times 4)$ in multiples of $T_{cy(WDCLK)} \times 4$.
- The Watchdog Clock (WDCLK) uses the IRC as the clock source.

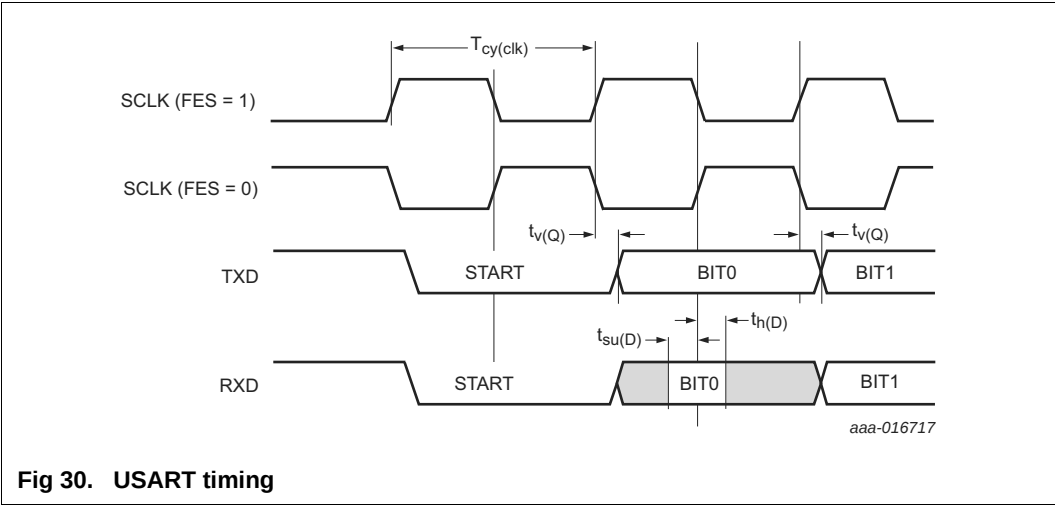


Fig 30. USART timing

Table 36. Dynamic characteristics: Ethernet

$T_{amb} = -40\text{ }^{\circ}\text{C}$ to $105\text{ }^{\circ}\text{C}$, $2.4\text{ V} \leq V_{DD(REG)(3V3)} \leq 3.6\text{ V}$; $2.7\text{ V} \leq V_{DD(IO)} \leq 3.6\text{ V}$. Values guaranteed by design.

Symbol	Parameter	Conditions		Min	Max	Unit
RMII mode						
f_{clk}	clock frequency	for ENET_RX_CLK	[1]	-	50	MHz
δ_{clk}	clock duty cycle		[1]	50	50	%
t_{su}	set-up time	for ENET_TXDn, ENET_TX_EN, ENET_RXDn, ENET_RX_ER, ENET_RX_DV	[1][2]	4	-	ns
t_h	hold time	for ENET_TXDn, ENET_TX_EN, ENET_RXDn, ENET_RX_ER, ENET_RX_DV	[1][2]	2	-	ns
MII mode						
f_{clk}	clock frequency	for ENET_TX_CLK	[1]	-	25	MHz
δ_{clk}	clock duty cycle		[1]	50	50	%
t_{su}	set-up time	for ENET_TXDn, ENET_TX_EN, ENET_TX_ER	[1][2]	4	-	ns
t_h	hold time	for ENET_TXDn, ENET_TX_EN, ENET_TX_ER	[1][2]	2	-	ns
f_{clk}	clock frequency	for ENET_RX_CLK	[1]	-	25	MHz
δ_{clk}	clock duty cycle		[1]	50	50	%
t_{su}	set-up time	for ENET_RXDn, ENET_RX_ER, ENET_RX_DV	[1][2]	4	-	ns
t_h	hold time	for ENET_RXDn, ENET_RX_ER, ENET_RX_DV	[1][2]	2	-	ns

[1] Output drivers can drive a load $\geq 25\text{ pF}$ accommodating over 12 inch of PCB trace and the input capacitance of the receiving device.

[2] Timing values are given from the point at which the clock signal waveform crosses 1.4 V to the valid input or output level.

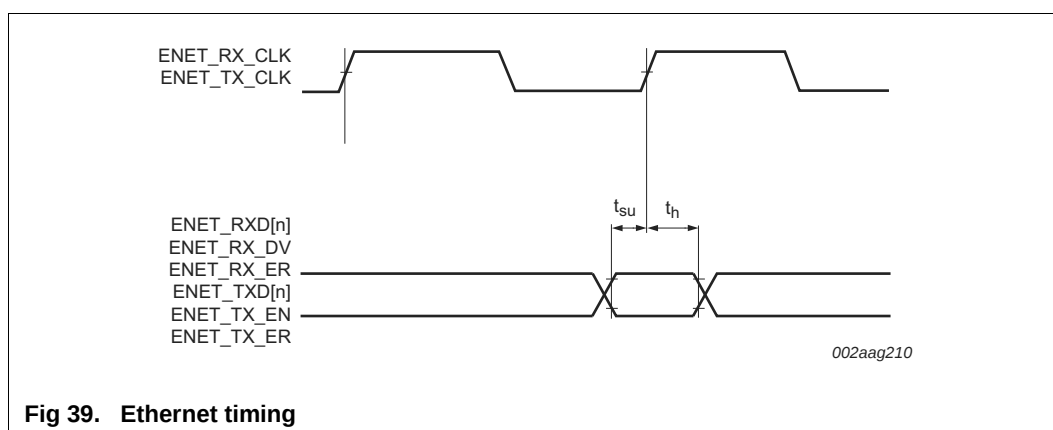
**Fig 39. Ethernet timing**

Table 42. LCD panel connections for STN dual panel mode

External pin	4-bit mono STN dual panel		8-bit mono STN dual panel		Color STN dual panel	
	LPC43xx pin used	LCD function	LPC43xx pin used	LCD function	LPC43xx pin used	LCD function
LCD_VD2	P4_3	UD[2]	P4_3	UD[2]	P4_3	UD[2]
LCD_VD1	P4_4	UD[1]	P4_4	UD[1]	P4_4	UD[1]
LCD_VD0	P4_1	UD[0]	P4_1	UD[0]	P4_1	UD[0]
LCD_LP	P7_6	LCDLP	P7_6	LCDLP	P7_6	LCDLP
LCD_ENAB/ LCDM	P4_6	LCDENAB/ LCDM	P4_6	LCDENAB/ LCDM	P4_6	LCDENAB/ LCDM
LCD_FP	P4_5	LCDFP	P4_5	LCDFP	P4_5	LCDFP
LCD_DCLK	P4_7	LCDDCLK	P4_7	LCDDCLK	P4_7	LCDDCLK
LCD_LE	P7_0	LCDLE	P7_0	LCDLE	P7_0	LCDLE
LCD_PWR	P7_7	LCDPWR	P7_7	LCDPWR	P7_7	LCDPWR
GP_CLKIN	PF_4	LCDCLKIN	PF_4	LCDCLKIN	PF_4	LCDCLKIN

Table 43. LCD panel connections for TFT panels

External pin	TFT 12 bit (4:4:4 mode)		TFT 16 bit (5:6:5 mode)		TFT 16 bit (1:5:5:5 mode)		TFT 24 bit	
	LPC43xx pin used	LCD function	LPC43xx pin used	LCD function	LPC43xx pin used	LCD function	LPC43xx pin used	LCD function
LCD_VD23	PB_0	BLUE3	PB_0	BLUE4	PB_0	BLUE4	PB_0	BLUE7
LCD_VD22	PB_1	BLUE2	PB_1	BLUE3	PB_1	BLUE3	PB_1	BLUE6
LCD_VD21	PB_2	BLUE1	PB_2	BLUE2	PB_2	BLUE2	PB_2	BLUE5
LCD_VD20	PB_3	BLUE0	PB_3	BLUE1	PB_3	BLUE1	PB_3	BLUE4
LCD_VD19	-	-	P7_1	BLUE0	P7_1	BLUE0	P7_1	BLUE3
LCD_VD18	-	-	-	-	P7_2	intensity	P7_2	BLUE2
LCD_VD17	-	-	-	-	-	-	P7_3	BLUE1
LCD_VD16	-	-	-	-	-	-	P7_4	BLUE0
LCD_VD15	PB_4	GREEN3	PB_4	GREEN5	PB_4	GREEN4	PB_4	GREEN7
LCD_VD14	PB_5	GREEN2	PB_5	GREEN4	PB_5	GREEN3	PB_5	GREEN6
LCD_VD13	PB_6	GREEN1	PB_6	GREEN3	PB_6	GREEN2	PB_6	GREEN5
LCD_VD12	P8_3	GREEN0	P8_3	GREEN2	P8_3	GREEN1	P8_3	GREEN4
LCD_VD11	-	-	P4_9	GREEN1	P4_9	GREEN0	P4_9	GREEN3
LCD_VD10	-	-	P4_10	GREEN0	P4_10	intensity	P4_10	GREEN2
LCD_VD9	-	-	-	-	-	-	P4_8	GREEN1
LCD_VD8	-	-	-	-	-	-	P7_5	GREEN0
LCD_VD7	P8_4	RED3	P8_4	RED4	P8_4	RED4	P8_4	RED7
LCD_VD6	P8_5	RED2	P8_5	RED3	P8_5	RED3	P8_5	RED6
LCD_VD5	P8_6	RED1	P8_6	RED2	P8_6	RED2	P8_6	RED5
LCD_VD4	P8_7	RED0	P8_7	RED1	P8_7	RED1	P8_7	RED4
LCD_VD3	-	-	P4_2	RED0	P4_2	RED0	P4_2	RED3
LCD_VD2	-	-	-	-	P4_3	intensity	P4_3	RED2
LCD_VD1	-	-	-	-	-	-	P4_4	RED1

15. Soldering

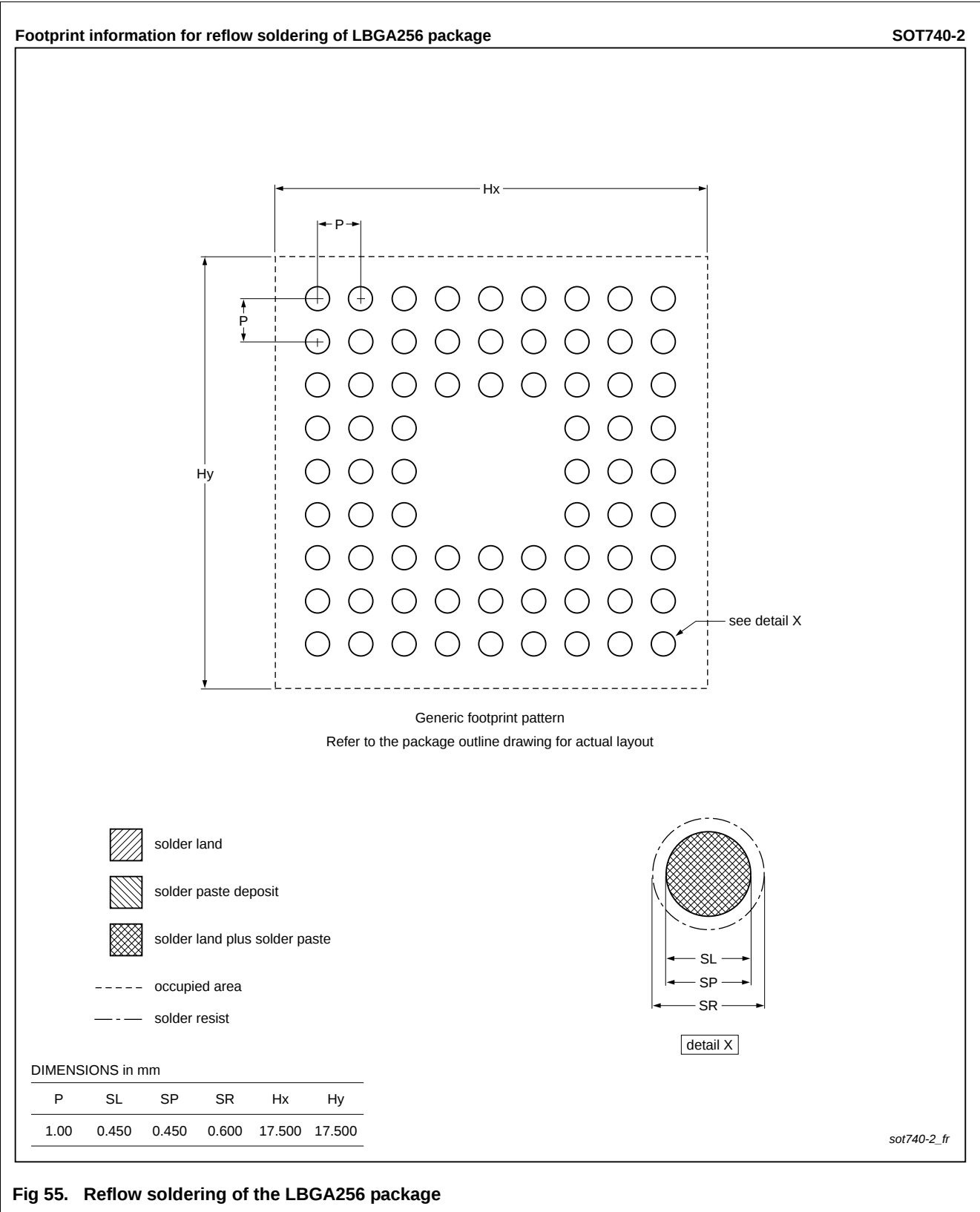


Fig 55. Reflow soldering of the LBG256 package

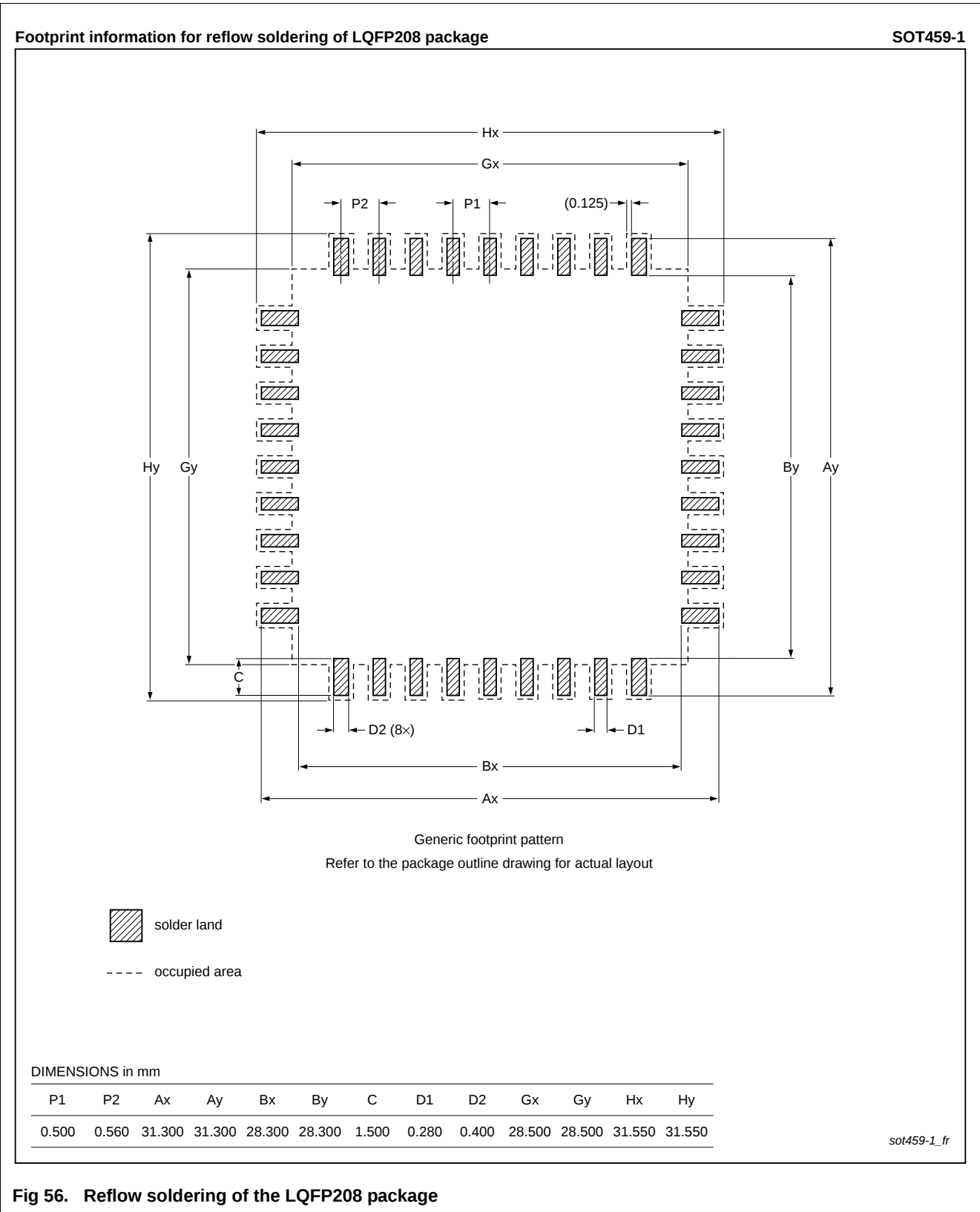


Fig 56. Reflow soldering of the LQFP208 package

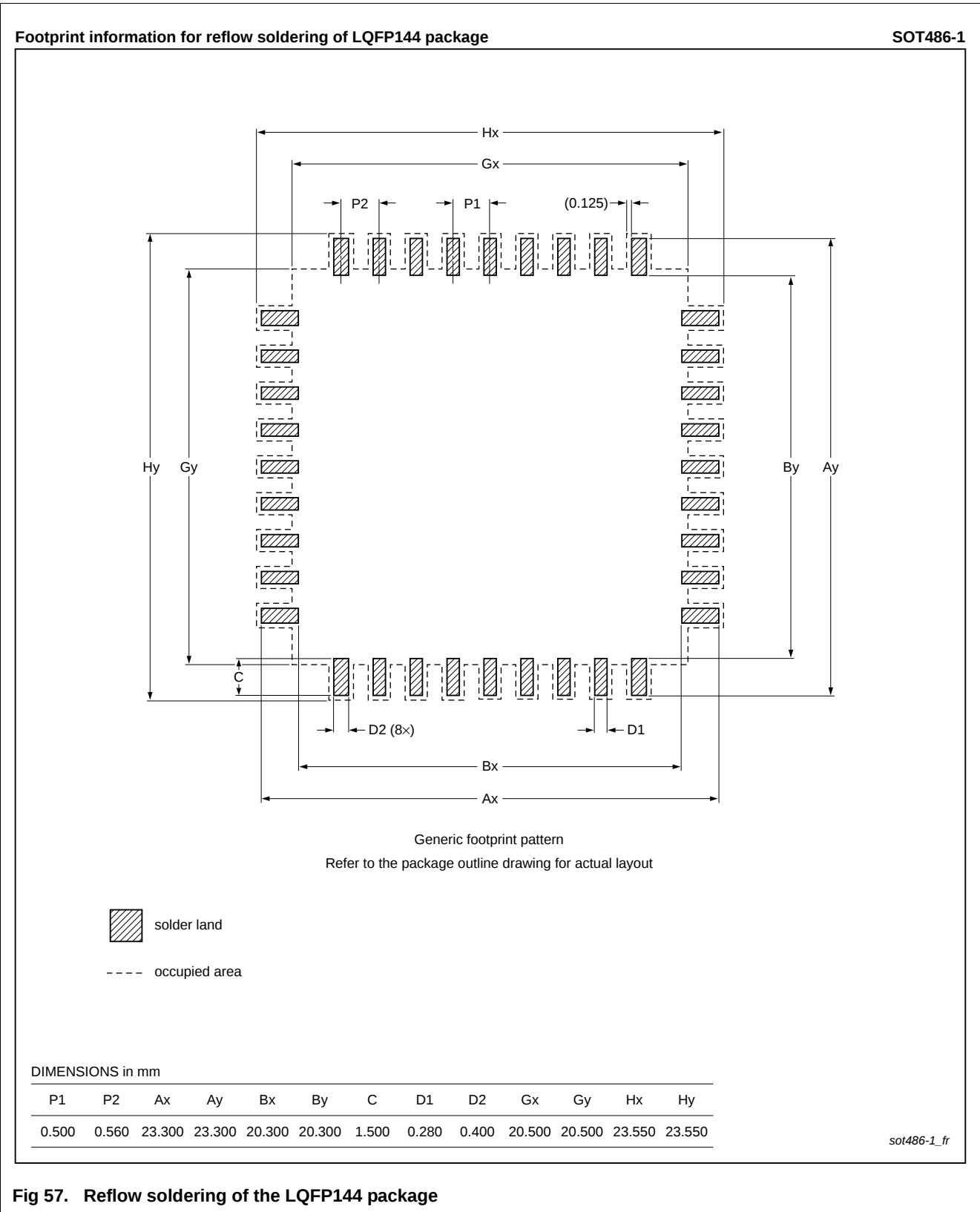


Fig 57. Reflow soldering of the LQFP144 package

Table 47. Revision history ...continued

Document ID	Release date	Data sheet status	Change notice	Supersedes
LPC4357_53_37_33 v.2	20120711	Preliminary data sheet	-	LPC4357_53 v.1
Modifications:	• Data sheet status changed to preliminary. • Parts LPC4337 and LPC4333 added. • Minimum value of V_I for conditions "USB0 pins USB0_DP; USB0_DM; USB0_VBUS", "USB0 pins USB0_ID; USB0_RREF", and "USB1 pins USB1_DP and USB1_DM" changed to -0.3 V in Table 6. • Section 10.2 added. • Table 8 "Thermal resistance (LQFP packages)" and Table 9 "Thermal resistance value (BGA packages)" added. • AES removed. Available on parts LPC43Sxx only. • Dynamic characteristics of the SD/MMC controller updated in Table 30. • Dynamic characteristics of the LCD controller updated in Table 31. • Dynamic characteristics of the SSP controller updated in Table 23. • Parameters I_{IL} and I_{IH} renamed to I_{LL} and I_{LH} in Table 10.			
LPC4357_53 v.1	20120604	Objective data sheet	-	-

7.23.5	PLL0USB (for USB0)	84	16	Abbreviations	152
7.23.6	PLL0AUDIO (for audio)	84	17	References	153
7.23.7	System PLL1	85	18	Revision history	154
7.23.8	Reset Generation Unit (RGU)	85	19	Legal information	159
7.23.9	Power Management Controller (PMC)	85	19.1	Data sheet status	159
7.23.10	Power control	86	19.2	Definitions	159
7.23.11	Code security (Code Read Protection - CRP)	87	19.3	Disclaimers	159
7.24	Serial Wire Debug/JTAG	88	19.4	Trademarks	160
8	Limiting values	89	20	Contact information	160
9	Thermal characteristics	90	21	Contents	161
10	Static characteristics	91			
10.1	Power consumption	98			
10.2	Peripheral power consumption	101			
10.3	Electrical pin characteristics	103			
10.4	BOD and band gap static characteristics	107			
11	Dynamic characteristics	108			
11.1	Flash/EEPROM memory	108			
11.2	Wake-up times	109			
11.3	External clock for oscillator in slave mode	109			
11.4	Crystal oscillator	110			
11.5	IRC oscillator	110			
11.6	RTC oscillator	110			
11.7	GPCLKIN	111			
11.8	I/O pins	111			
11.9	I ² C-bus	112			
11.10	I ² S-bus interface	113			
11.11	USART interface	114			
11.12	SSP interface	116			
11.13	SPI interface	119			
11.14	SSP/SPI timing diagrams	120			
11.15	SPFI	122			
11.16	SGPIO timing	122			
11.17	External memory interface	124			
11.18	USB interface	129			
11.19	Ethernet	130			
11.20	SD/MMC	132			
11.21	LCD	132			
12	ADC/DAC electrical characteristics	133			
13	Application information	136			
13.1	LCD panel signal usage	136			
13.2	Crystal oscillator	138			
13.3	RTC oscillator	140			
13.4	XTAL and RTCX Printed Circuit Board (PCB) layout guidelines	140			
13.5	Standard I/O pin configuration	140			
13.5.1	Reset pin configuration	141			
13.5.2	Suggested USB interface solutions	141			
14	Package outline	144			
15	Soldering	148			

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